## ABSTRACT

The present invention provides a connector chip preventing electrical shorting between capable οf adjoining electrodes and also capable of readily connecting a plurality of electrodes on a first circuit substrate and a plurality of electrodes on a second circuit substrate without using a dedicated mounting device or the A plurality of conductive paths 5 are formed on an outer periphery surface constituted by continuous four surfaces 9A to 9D of an insulating substrate 3 including six surfaces of the surfaces 9A to 9D and surfaces 9E and Each of the conductive paths 5 goes round on the outer 9F. periphery surface. The conductive paths 5 are formed on the outer periphery surface at a predetermined interval in an opposing direction in which the remaining two surfaces 9E and 9F are opposing to each other. Each of insulating layers 7 having a property of repelling molten solder is formed between portions of each two adjoining conductive paths located on a pair of the surfaces 9A and The width of a conductive-path-formed portion 3A with a conductive path 5 formed thereon, orthogonal to a center line C is formed to be smaller than the width of a conductive-path-unformed portion 3B with no conductive path 5 formed thereon, orthogonal to the center line C.